

REMARKS/ARGUMENTS

Claim 13 and 17 remain in the application. Claims 11, 12, 14, 15, 16 and 18 have been amended. No new matter has been added.

Reconsideration of the rejection of Claims 11-18 under 37 CFR 1.113, is requested, in light of the following arguments.

Briefly, applicants wish to point out the claimed invention which is a novel and cost-effective process for stripping and cleaning organic coatings. The removal of residual adhesive materials from sidewalls formed in etched metallic layers of dense submicron topography on semiconductor wafers while being contained in a cassette. The cleaning process is accomplished by providing a tank containing a liquid chemical and a quartz gas distribution plate placed on the bottom of the tank. The quartz plate contains a trough for guiding a flexible tubing and a plurality of drill guide holes for drilling a linear array of holes in the guided tubing. The tubing is connected to a pressure regulated gas supply. The wafer cassette is positioned on the quartz gas distribution plate so that a linear array of gas bubbles emanating from the holes drilled in the flexible tubing, flow upwards while scrubbing the surfaces of each wafer.

The method of claims 11 and 15 , and the manner as illustrated in Figs. 2 are

neither taught nor suggested by the prior art.

We have reviewed the related art references made of record and have determined that none of these suggest the present claimed invention.

Applicant respectfully requests that a timely Notice of Allowance be issued in this case.

Respectfully submitted,

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Steven E. Koffs

Steven E. Koffs, Reg. No.: 37,163

Attorney For Applicants

DUANE MORRIS LLP
One Liberty Place
Philadelphia, Pennsylvania 19103-7396
(215) 979-1250 (Telephone)
(215) 979-1020 (Fax)